



PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of  
Mitsubishi AOKI et al.

Serial No. 09/715,000

GROUP 2811

Filed November 20, 2000

Examiner L. Thai

IMPROVED SEMICONDUCTOR WAFER  
SURFACE AND METHOD OF TREATING  
A SEMICONDUCTOR WAFER SURFACE

AMENDMENT

Commissioner for Patents

Washington, D.C. 20231

Sir:

Responsive to the Official Action of October 17, 2001,  
please amend the above-identified application as follows:

IN THE CLAIMS:

✓  
Cancel claims 34-56.

R E M A R K S

Responsive to the requirement for restriction,  
Applicant elects Group I, claims 1-33 drawn to the method,  
without traverse.

Non-elected claims 34-56 are cancelled herewith.

An action on the merits of the elected claims is  
respectfully requested.

Respectfully submitted,

YOUNG & THOMPSON

By

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November 8, 2001

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